

DATASHEET

Chip Photodiode with Right Angle Lens PD12-21B/TR8



Features

- Fast response time
- · High photo sensitivity
- Small junction capacitance
- Package in 8mm tape in "7" diameter reel
- Pb free
- The product itself will remain within RoHS compliant version.
- Compliance with EU REACH
- Compliance Halogen Free .(Br <900 ppm , Cl <900 ppm , Br+Cl < 1500 ppm).

Descriptions

 PD12-21B/TR8 is a high speed and high sensitive
 PIN photodiode in miniature flat top view lens SMD package and it is molded in a black epoxy. The device is spectrally matched to infrared emitting diode.

Applications

- High speed photo detector
- Copier
- Game machine

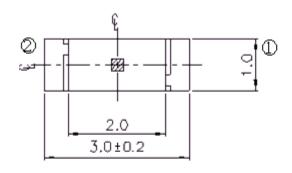
Device Selection Guide

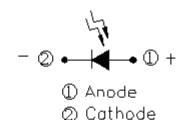
Part Category	Chip Material	Lens Color
PD	Silicon	Black

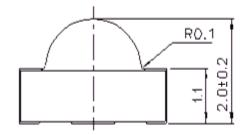


Package Dimensions

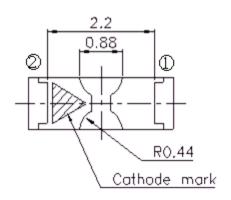
PD12-21B/TR8

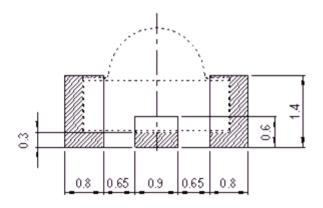






For reflow soldering (propose)





Notes: 1.All dimensions are in millimeters

- 2. Tolerances unless dimensions ±0.1mm
- 3.Suggested pad dimension is just for reference only.

 Please modify the pad dimension based on individual need.



Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Rating	Units	
Reverse Voltage	V_{R}	32	V	
Operating Temperature	T_{opr}	-25 ~ +85	$^{\circ}\! \mathbb{C}$	
Storage Temperature	T _{stg}	-40 ~ +85	$^{\circ}\!\mathbb{C}$	
Soldering Temperature *1	T _{sol}	260	$^{\circ}\!\mathbb{C}$	
Power Dissipation at (or below) 25°C Free Air Temperature	P _d	150	mW	

Notes: *1: Soldering time ≤ 5 seconds.

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Units
Range Of Spectral Bandwidth	λ _{0.5}		730		1050	nm
Wavelength Of Peak Sensitivity	λ_{P}			940	-	nm
Open-Circuit Voltage	V _{oc}	Ee=1mW/cm ² λ_P =875nm		0.42		٧
Short-Circuit Current	I _{SC}	Ee=1mW/cm ² λ_P =875nm		1.3		μA
Reverse Light Current	IL	Ee=1mW/cm ² λ_P =875nm V_R =5V	0.7	1.5		μΑ
Dark Current	I _D	$ \begin{array}{c} \text{Ee=0mW/cm}^2 \\ \text{V}_{\text{R}} = 10 \text{V} \end{array} $			10	nA
Reverse Breakdown Voltage	V_{BR}	Ee=0mW/cm ² I _R =100μA	33	170		V



Typical Electro-Optical Characteristics Curves

Fig.1 Spectral Sensitivity

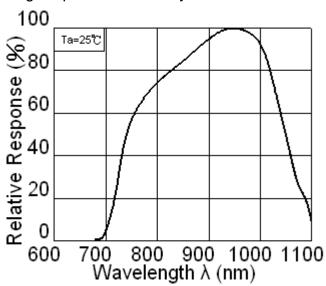
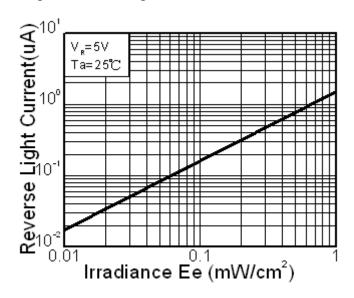


Fig.2 Reverse Light Current vs. Ee





Precautions For Use

1. Over-current-proof

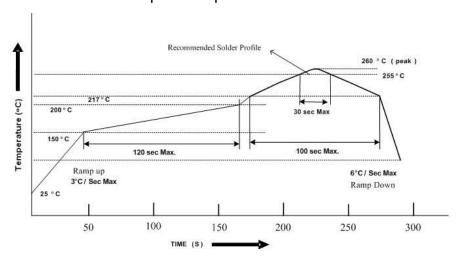
Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 10°C ~30°C and 90%RH or less.
- 2.3 The LEDs suggested be used within one year.
- 2.4 After opening the package, the devices must be stored at 10°C~30°C and ≤ 60%RH, and used within one year (floor life). If unused LEDs remain, it should be stored in moisture proof packages.
- 2.5 If the moisture absorbent material (desiccant material) has faded or unopened bag has exceeded the shelf life or devices (out of bag) have exceeded the floor life, baking treatment is required.
- 2.6 If baking is required, refer to IPC/JEDEC J-STD-033 for bake procedure or recommend the following conditions:
 - 96 hours at 60°C ± 5°C and < 5 % RH (reeled/tubed/loose units)

3. Soldering Condition

3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

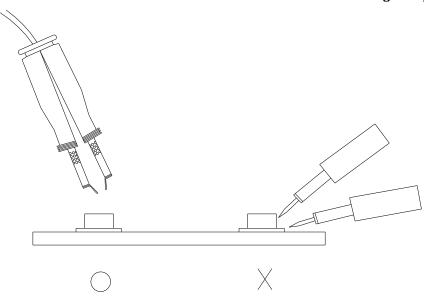


4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

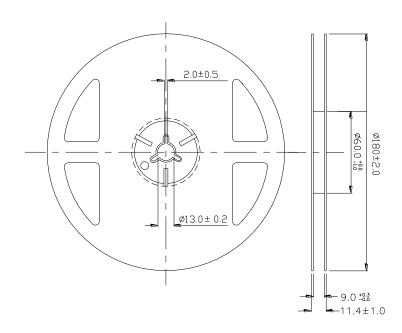
5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



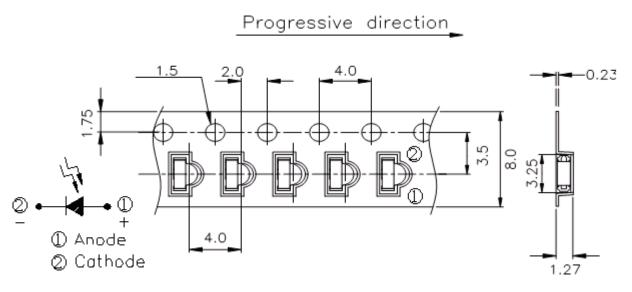


Package Dimensions



Note: The tolerances unless mentioned are ±0.1mm, Unit: mm

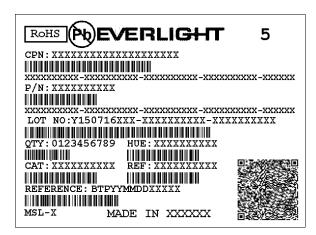
Carrier Taping Dimensions: Loaded Quantity 2000PCS/Reel



Note: The tolerances unless mentioned are ±0.1mm, Unit: mm



Label Form Specification



CPN: Customer's Production Number

P/N : Production Number LOT No: Lot Number QTY: Packing Quantity

HUE: Peak Wavelength

CAT: Ranks REF: Reference MSL-X: MSL Level

Made In: Manufacture place

DISCLAIMER

- 1. EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
- 2. The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
- 3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
- 4. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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